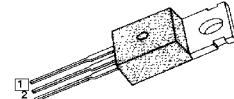


**FEATURES**

- ◆ Logic-Level Gate Drive
- ◆ Avalanche Rugged Technology
- ◆ Rugged Gate Oxide Technology
- ◆ Lower Input Capacitance
- ◆ Improved Gate Charge
- ◆ Extended Safe Operating Area
- ◆ Lower Leakage Current: 10 $\mu$ A (Max.) @ V<sub>DS</sub> = 200V
- ◆ Lower R<sub>DS(ON)</sub>: 0.609 $\Omega$  (Typ.)

BV<sub>DSS</sub> = 200 VR<sub>DS(on)</sub> = 0.8 $\Omega$ I<sub>D</sub> = 5 A

TO-220



1.Gate 2.Drain 3.Source

**Absolute Maximum Ratings**

Symbol	Characteristic	Value	Units
V <sub>DSS</sub>	Drain-to-Source Voltage	200	V
I <sub>D</sub>	Continuous Drain Current (T <sub>C</sub> =25°C)	5	A
	Continuous Drain Current (T <sub>C</sub> =100°C)	3.2	
I <sub>DM</sub>	Drain Current-Pulsed (1)	18	A
V <sub>GS</sub>	Gate-to-Source Voltage	$\pm 20$	V
E <sub>AS</sub>	Single Pulsed Avalanche Energy (2)	33	mJ
I <sub>AR</sub>	Avalanche Current (1)	5	A
E <sub>AR</sub>	Repetitive Avalanche Energy (1)	3.9	mJ
dv/dt	Peak Diode Recovery dv/dt (3)	5	V/ns
P <sub>D</sub>	Total Power Dissipation (T <sub>C</sub> =25°C)	39	W
	Linear Derating Factor	0.31	W/ $^{\circ}$ C
T <sub>J</sub> , T <sub>STG</sub>	Operating Junction and Storage Temperature Range	- 55 to +150	$^{\circ}$ C
T <sub>L</sub>	Maximum Lead Temp. for Soldering Purposes, 1/8. from case for 5-seconds	300	

**Thermal Resistance**

Symbol	Characteristic	Typ.	Max.	Units
R <sub>θJC</sub>	Junction-to-Case	--	3.17	$^{\circ}$ C/W
R <sub>θCS</sub>	Case-to-Sink	0.5	--	
R <sub>θJA</sub>	Junction-to-Ambient	--	62.5	

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## Electrical Characteristics ( $T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Characteristic	Min.	Typ.	Max.	Units	Test Condition
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	200	--	--	V	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_D=250\mu\text{A}$
$\Delta \text{BV}/\Delta T_J$	Breakdown Voltage Temp. Coeff.	--	0.18	--	$\text{V}/^\circ\text{C}$	$\text{I}_D=250\mu\text{A}$ See Fig 7
$\text{V}_{\text{GS(th)}}$	Gate Threshold Voltage	1.0	--	2.0	V	$\text{V}_{\text{DS}}=5\text{V}, \text{I}_D=250\mu\text{A}$
$\text{I}_{\text{GSS}}$	Gate-Source Leakage, Forward	--	--	100	nA	$\text{V}_{\text{GS}}=20\text{V}$
	Gate-Source Leakage, Reverse	--	--	-100		$\text{V}_{\text{GS}}=-20\text{V}$
$\text{I}_{\text{DSS}}$	Drain-to-Source Leakage Current	--	--	10	$\mu\text{A}$	$\text{V}_{\text{DS}}=200\text{V}$
		--	--	100		$\text{V}_{\text{DS}}=160\text{V}, \text{T}_C=125^\circ\text{C}$
$\text{R}_{\text{DS(on)}}$	Static Drain-Source On-State Resistance	--	--	0.8	$\Omega$	$\text{V}_{\text{GS}}=5\text{V}, \text{I}_D=2.5\text{A}$ (4)
$\text{g}_f$	Forward Transconductance	--	3.3	--	$\text{O}$	$\text{V}_{\text{DS}}=40\text{V}, \text{I}_D=2.5\text{A}$ (4)
$\text{C}_{\text{iss}}$	Input Capacitance	--	330	430	pF	$\text{V}_{\text{GS}}=0\text{V}, \text{V}_{\text{DS}}=25\text{V}, f=1\text{MHz}$ See Fig 5
$\text{C}_{\text{oss}}$	Output Capacitance	--	55	70		
$\text{C}_{\text{rss}}$	Reverse Transfer Capacitance	--	25	30		
$t_{d(\text{on})}$	Turn-On Delay Time	--	8	25	ns	$\text{V}_{\text{DD}}=100\text{V}, \text{I}_D=5\text{A}, \text{R}_G=9\Omega$ See Fig 13 (4) (5)
$t_r$	Rise Time	--	6	20		
$t_{d(\text{off})}$	Turn-Off Delay Time	--	24	60		
$t_f$	Fall Time	--	6	20		
$\text{Q}_g$	Total Gate Charge	--	10.3	15	nC	$\text{V}_{\text{DS}}=160\text{V}, \text{V}_{\text{GS}}=5\text{V}, \text{I}_D=5\text{A}$ See Fig 6 & Fig 12 (4) (5)
$\text{Q}_{\text{gs}}$	Gate-Source Charge	--	2.0	--		
$\text{Q}_{\text{gd}}$	Gate-Drain (. Miller. ) Charge	--	4.4	--		

## Source-Drain Diode Ratings and Characteristics

Symbol	Characteristic	Min.	Typ.	Max.	Units	Test Condition
$\text{I}_S$	Continuous Source Current	--	--	5	A	Integral reverse pn-diode in the MOSFET
$\text{I}_{\text{SM}}$	Pulsed-Source Current (1)	--	--	18		
$\text{V}_{\text{SD}}$	Diode Forward Voltage (4)	--	--	1.5	V	$\text{T}_J=25^\circ\text{C}, \text{I}_S=5\text{A}, \text{V}_{\text{GS}}=0\text{V}$
$t_{rr}$	Reverse Recovery Time	--	140	--	ns	$\text{T}_J=25^\circ\text{C}, \text{I}_F=5\text{A}$
$\text{Q}_{\text{rr}}$	Reverse Recovery Charge	--	0.59	--	$\mu\text{C}$	$d\text{I}_F/dt=100\text{A}/\mu\text{s}$ (4)

### Notes:

(1) Repetitive Rating : Pulse Width Limited by Maximum Junction Temperature

(2)  $L=2\text{mH}$ ,  $\text{I}_{\text{AS}}=5\text{A}$ ,  $\text{V}_{\text{DD}}=50\text{V}$ ,  $\text{R}_G=27\Omega$ , Starting  $\text{T}_J=25^\circ\text{C}$

(3)  $\text{I}_{\text{SD}} \leq 5\text{A}$ ,  $d\text{I}/dt \leq 180\text{A}/\mu\text{s}$ ,  $\text{V}_{\text{DD}} \leq \text{BV}_{\text{DSS}}$ , Starting  $\text{T}_J=25^\circ\text{C}$

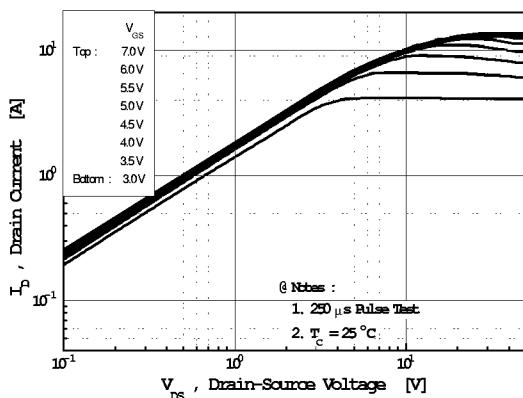
(4) Pulse Test : Pulse Width =  $250\mu\text{s}$ , Duty Cycle  $\leq 2\%$

(5) Essentially Independent of Operating Temperature

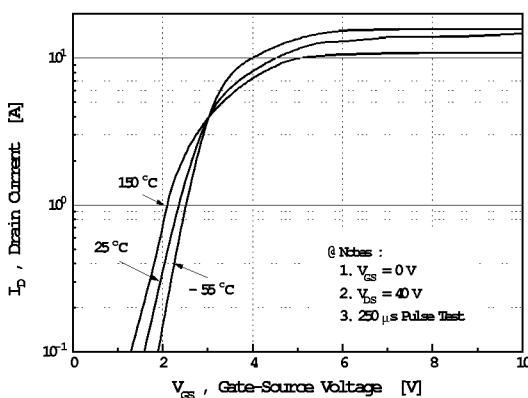
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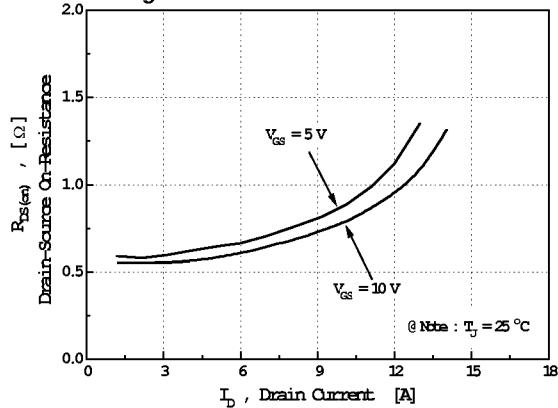
**Fig 1. Output Characteristics**



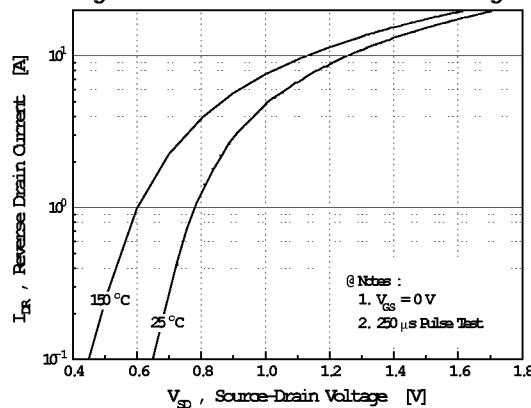
**Fig 2. Transfer Characteristics**



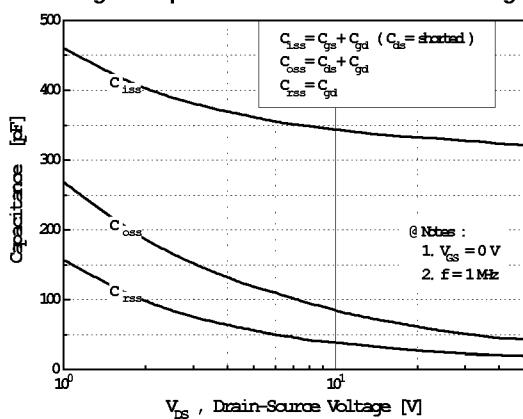
**Fig 3. On-Resistance vs. Drain Current**



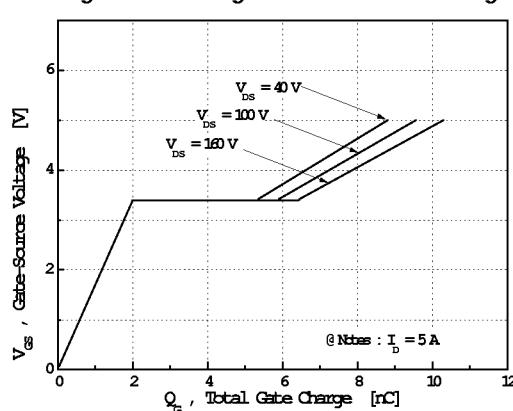
**Fig 4. Source-Drain Diode Forward Voltage**



**Fig 5. Capacitance vs. Drain-Source Voltage**



**Fig 6. Gate Charge vs. Gate-Source Voltage**



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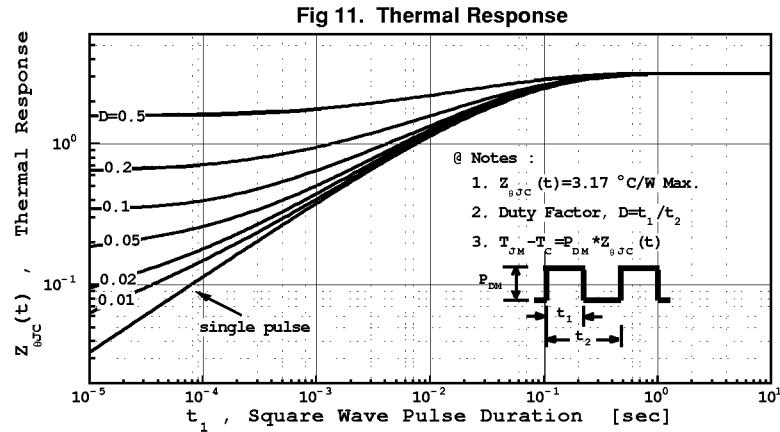
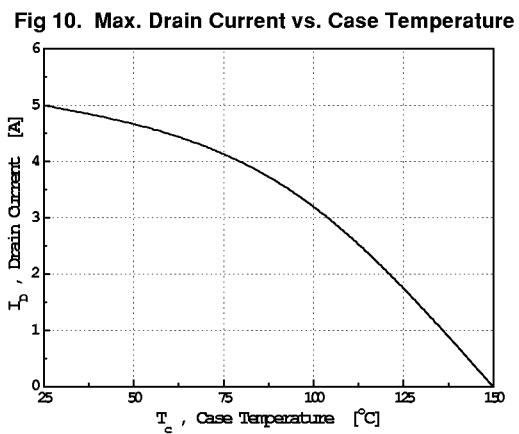
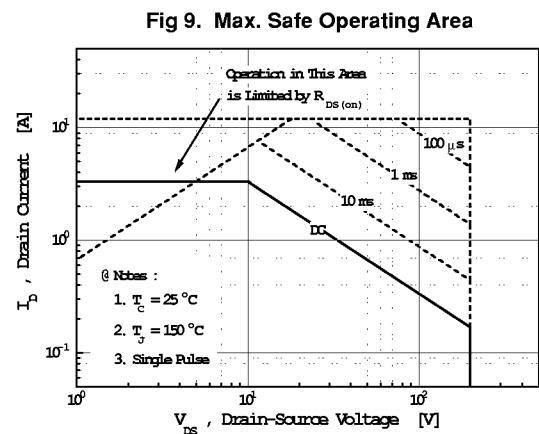
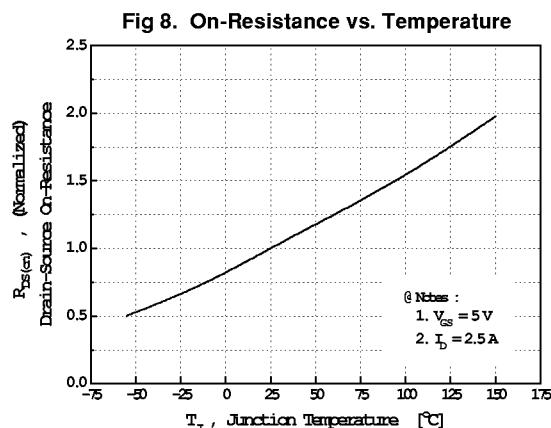
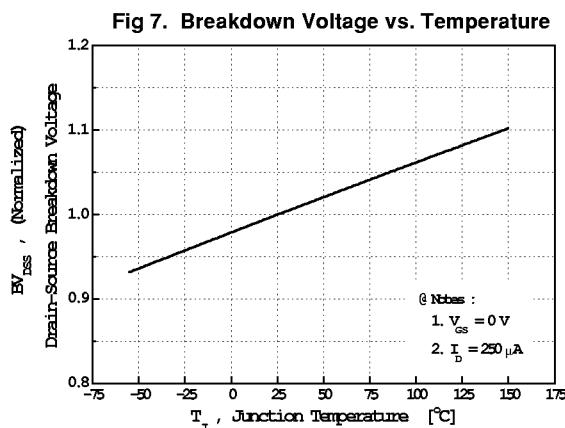


Fig 12. Gate Charge Test Circuit & Waveform

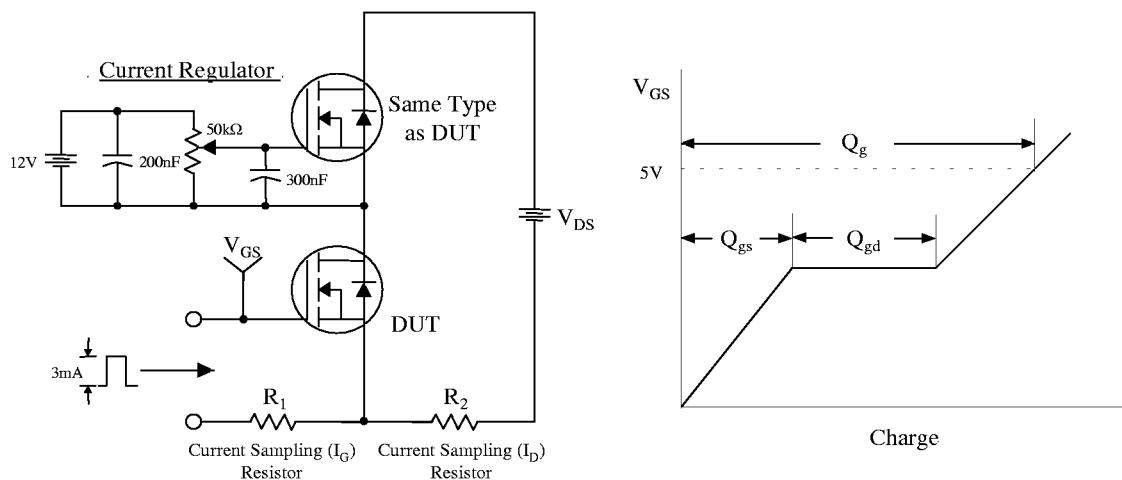


Fig 13. Resistive Switching Test Circuit & Waveforms

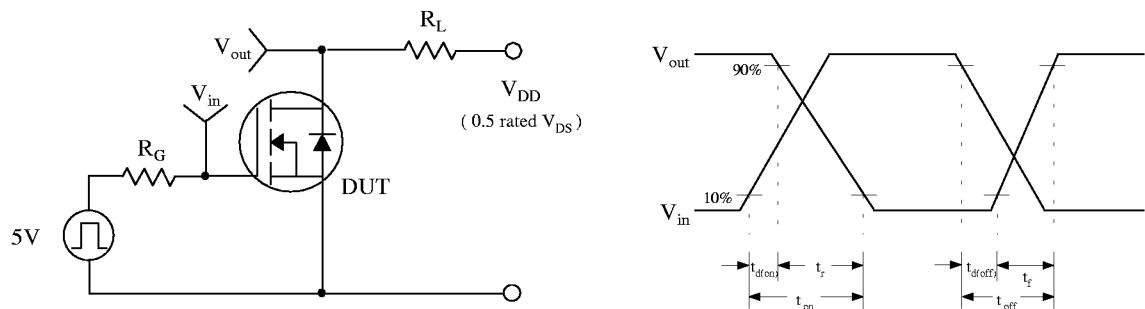
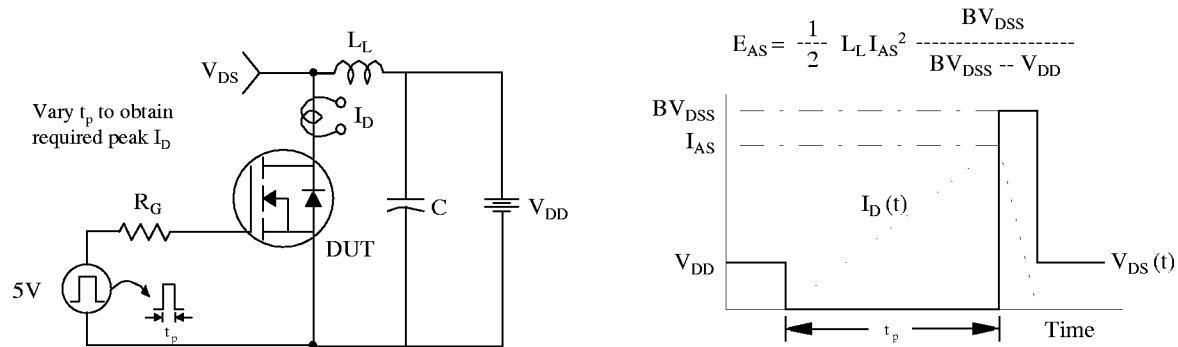


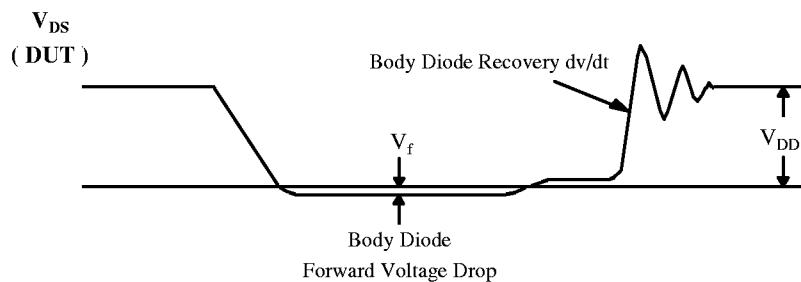
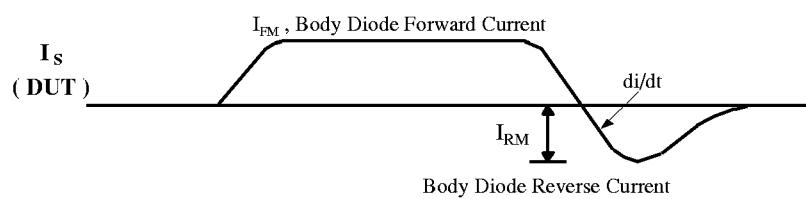
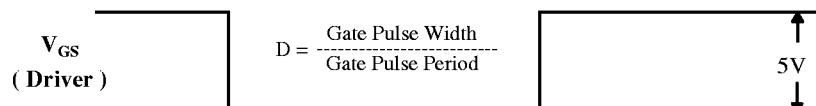
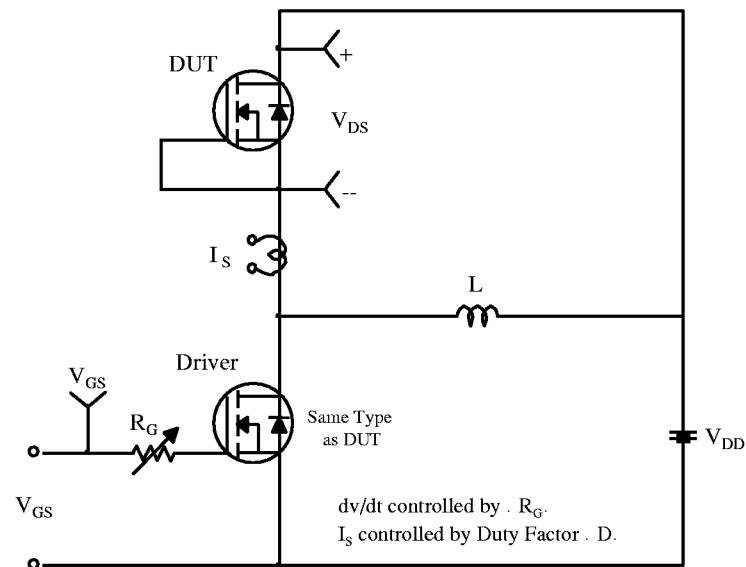
Fig 14. Unclamped Inductive Switching Test Circuit & Waveforms



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Fig 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms



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